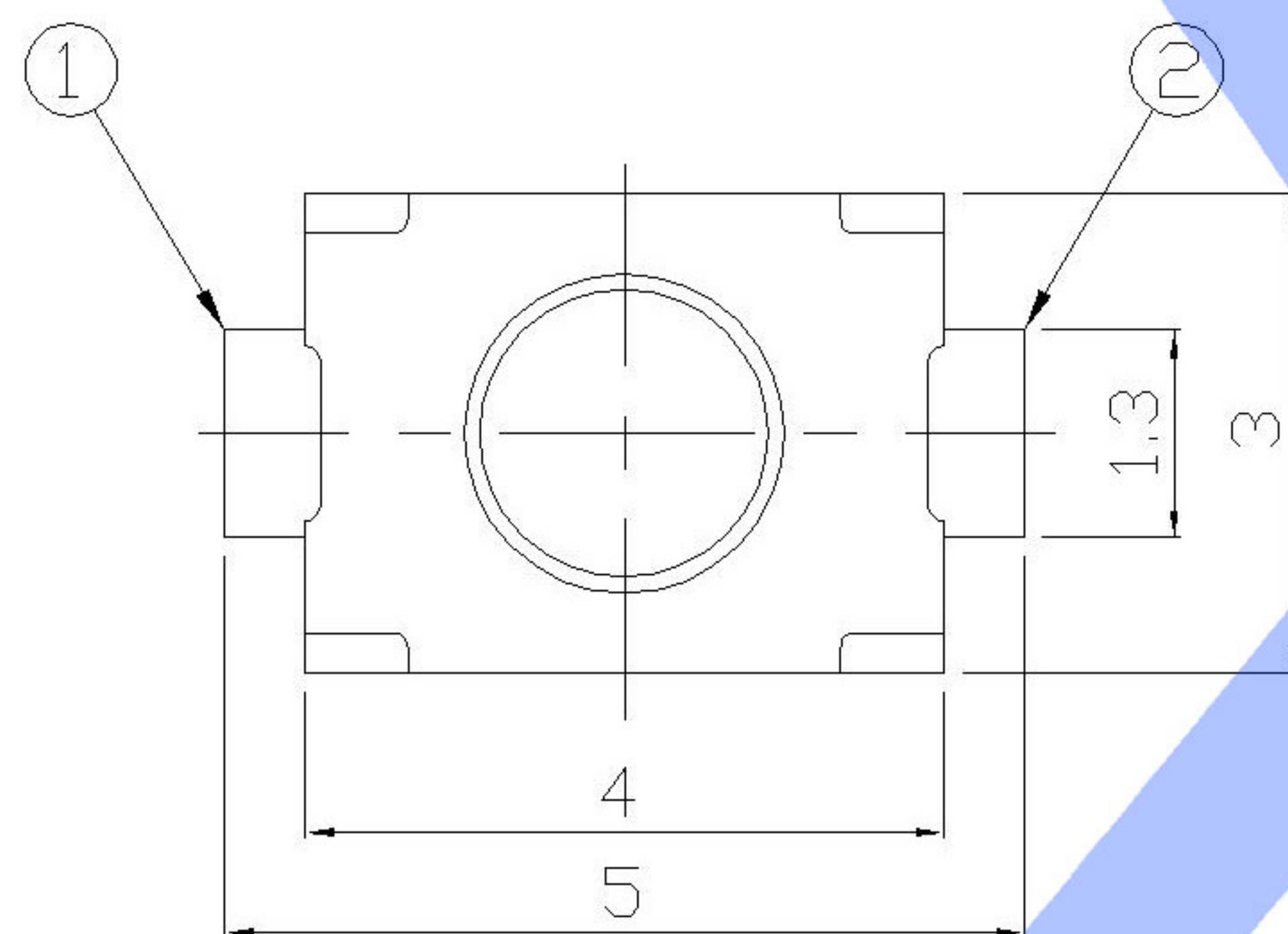
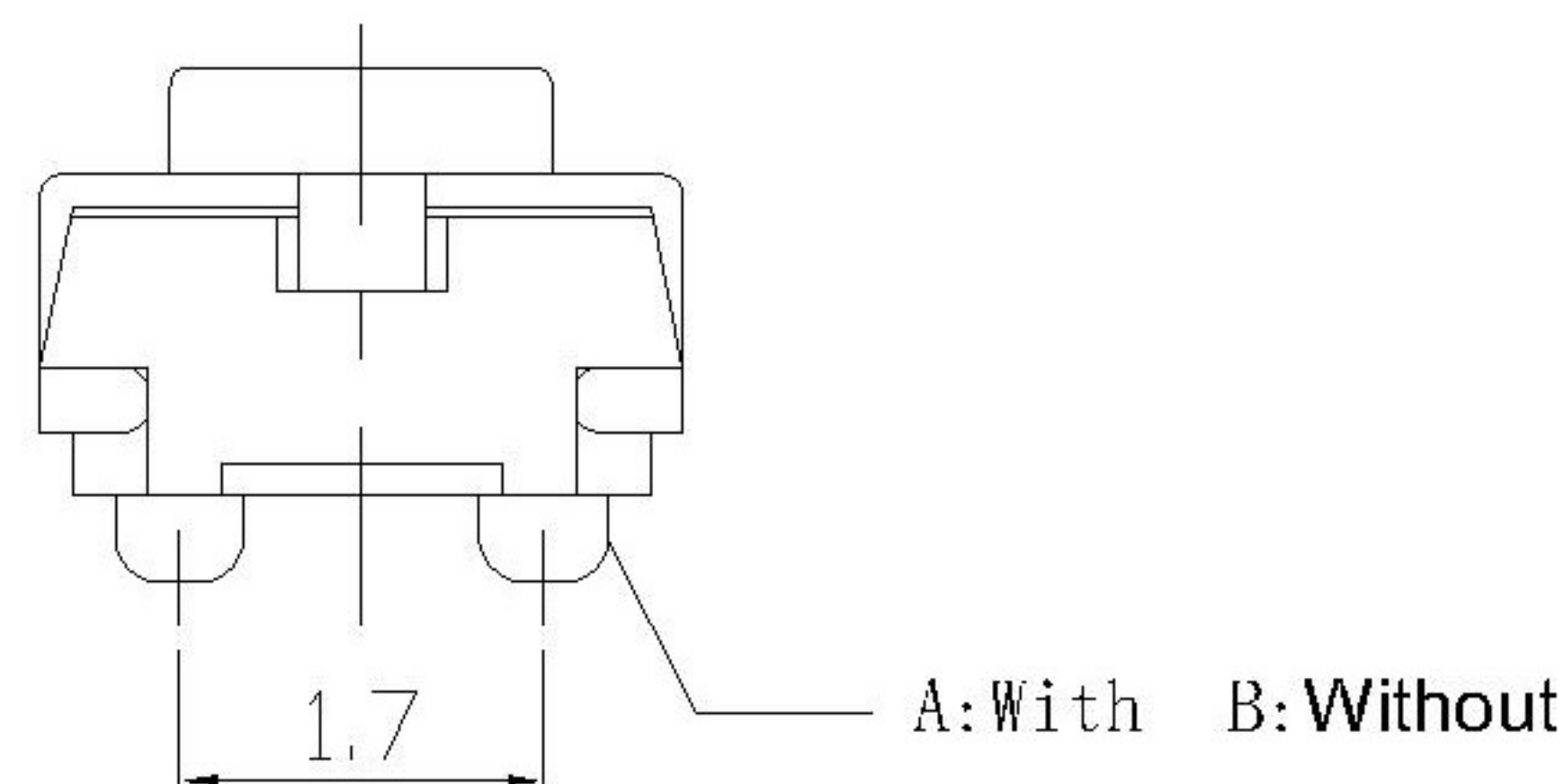
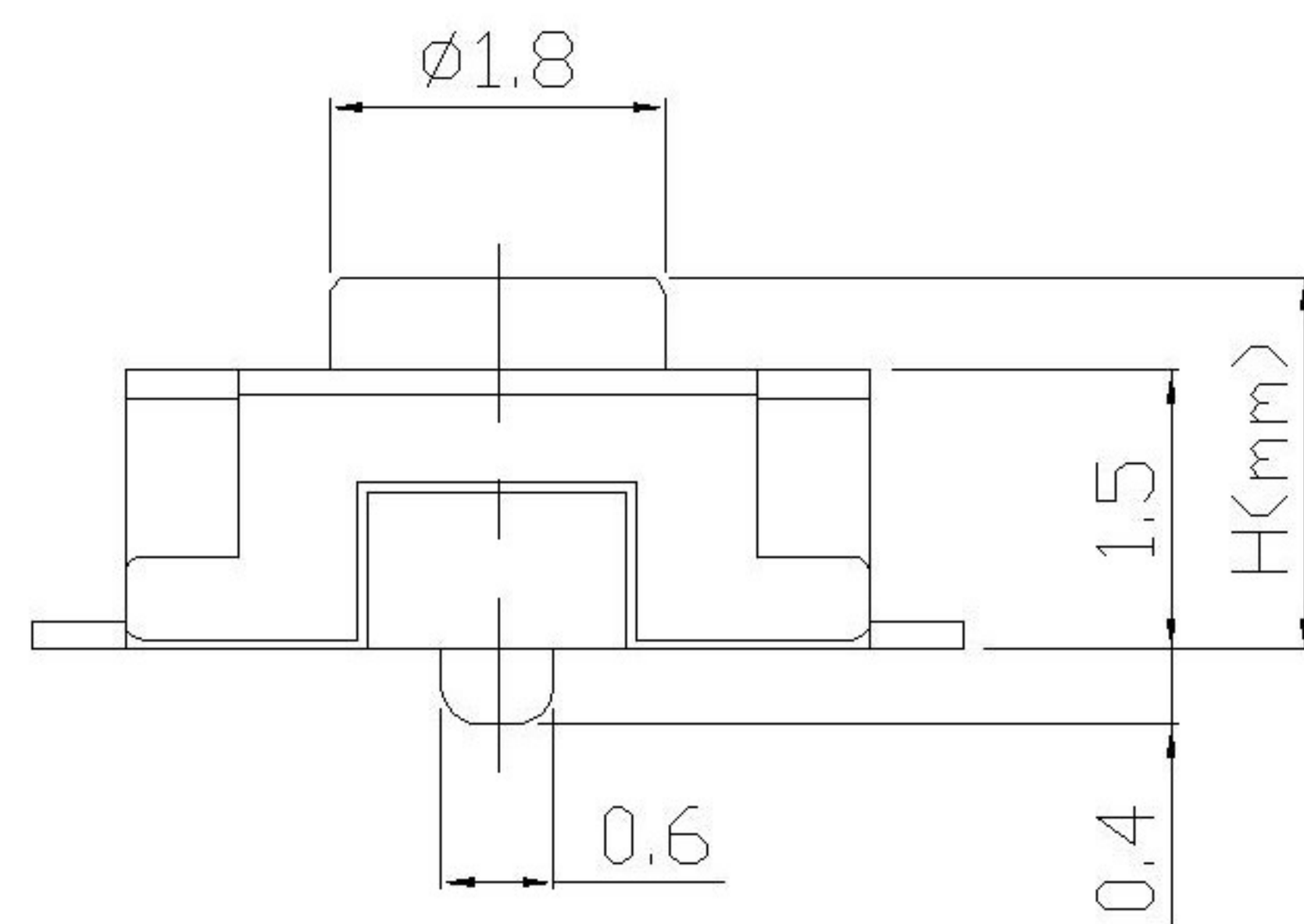
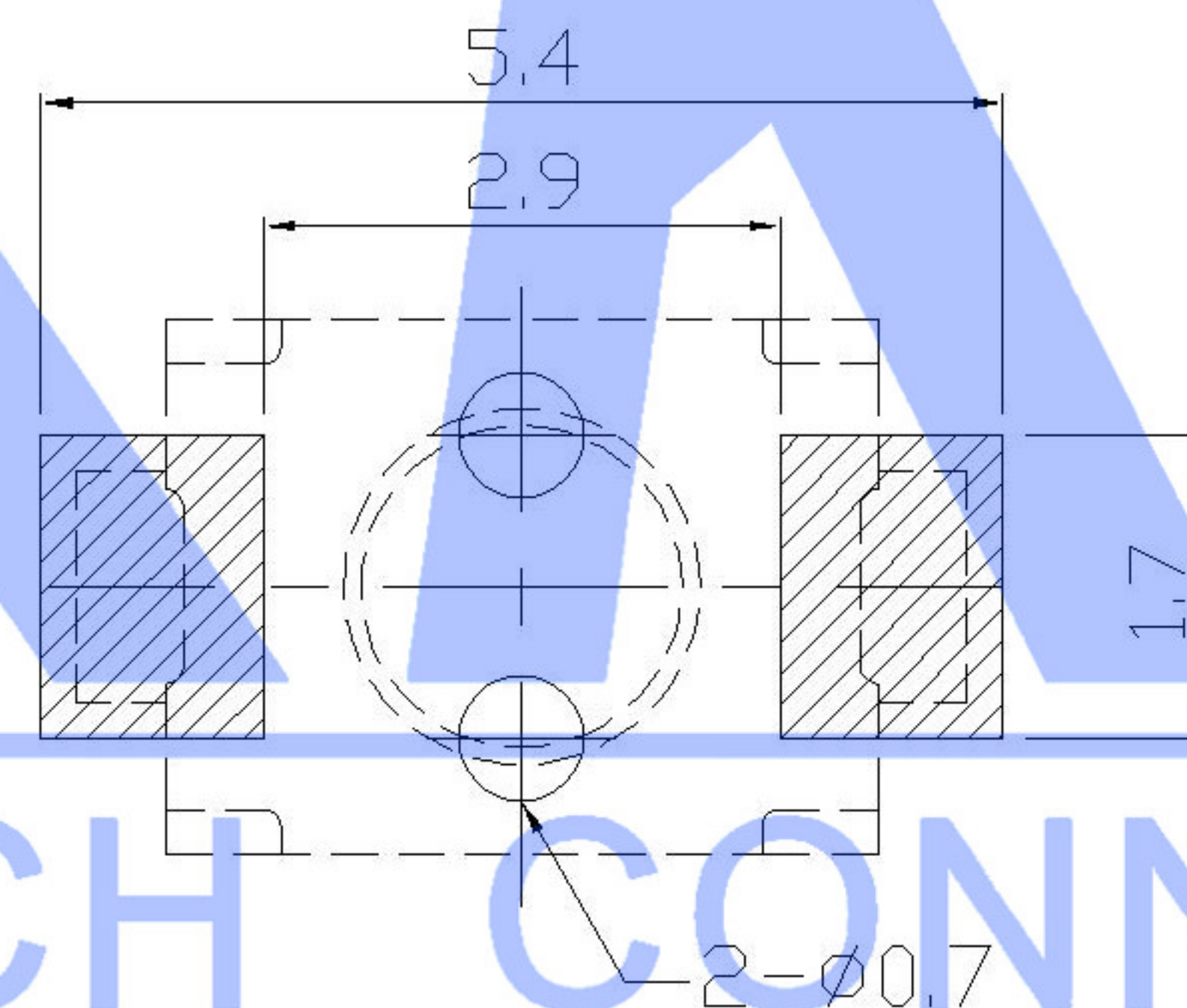
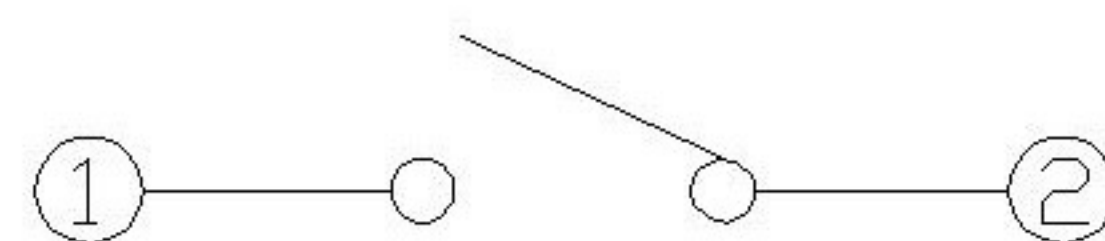




P.C.B MOUNTING PATTERN DIMENSION
The following soldering patterns are recommended for reflow soldering



CIRCUIT DIAGRAM

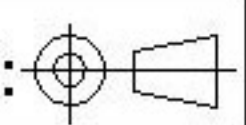


SPECIFICATION

Contact Rating :	50mA,12V DC
Contact Resistance :	100mΩ max
Insulation Resistance :	100mΩ min.500V DC
Dielectric Strength :	250V AC/1minute
Travel:	0.13mm
Operating Temp :	-30℃~+85℃
Storage Temp :	-30℃~+80℃

PAPT NO	TS-1185-X-X-X-B
Operating Force	A:100gf B:160gf C:260gf
Height	H:A:2.0 B:2.5
Fixed column	A:With B:Without
Keystake	A:PA46: B:Silica gel

⑤	Terminal	—	2	Brass (0.30t)	Plating silvering	—
④	Contact	—	1	F.ag/Sus	Natural	—
③	Base	—	1	Lcp		—
②	Cover	—	1	Brass	Plating Nickel	—
①	Keystake	—	1	Silica gel		—
ITEM	PAPT NAME	TER,NO	QTY	MATERIAL	FINISHING	REMARK

						DSND		DATE		SCALE: N/A	MODEL TYPE:
						DWN		DATE		VIEW: 	TACT SWITCH
						CHKD		DATE		UNIT: mm	PART NO.:
						APPD		DATE		SIZE: A4	DWG NO.:
										TS-1185-X-X-X-B	
										WEIGHT	SHEET
										1.0g	1/1
										REVISION	
										A0	

units: mm

tolerance:

X.X ±0.2mm

X.XX ±0.1mm

X.XXX ±0.05mm

UNSPECIFIED TOLERANCES

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